

# High Performance BGA Cooling Solutions w/ maxiGRIP™ Attachment



ATS Part#: **ATS-53190D-C1-R0**  
 Description: maxiGRIP™ HS Assembly-SF-LP, T766, BLACK-ANODIZED

Heat Sink Type: **Straight Fin**  
 Heat Sink Attachment: **maxiGRIP**  
 Equivalent Part Number: **ATS-53190D-C2-R0 Discontinued**

*\*Image above is for illustration purpose only.*

## Features & Benefits

- High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- **maxiGRIP™** attachment applies steady, even pressure to the component and does not require holes in the PCB
- Designed specifically for BGAs and other surface mount packages
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock Testing and Unpackaged Drop Testing standards
- Comes pre-assembled with high performance, phase changing, thermal interface material
- Designed for low profile components from 1.5 to 2.99mm
- "Keep-Out" Requirements: An "Un-Populated" border zone of 5mm around the component is necessary to facilitate the Installation/Removal of the **maxiGRIP™**. Please refer to the **maxiGRIP™** Keep-Out Guidelines and **maxiGRIP™** Installation/Removal Instructions for further details.

## Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	22.02 °C/W	17.49 °C/W	10.00 °C/W	10.00 °C/W	10.00 °C/W	10.00 °C/W	10.00 °C/W
	Ducted Flow	10.00	n/a	n/a	n/a	n/a	n/a	n/a

## Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
<p><i>*Image above is for illustration purpose only.</i></p>	19.0 mm	19.0 mm	9.5 mm	mm	T766	BLACK-ANODIZED
<b>Notes:</b> <ul style="list-style-type: none"> <li>• Dimension <b>A</b> and <b>B</b> refer to component size.</li> <li>• Dimension <b>C</b> is the heat sink height from the bottom of the base to the top of the fin field.</li> <li>• ATS-53190D-C2-R0 is the exact heat sink assembly with an equivalent thermal interface material (Saint Gobain C1100F). NOTE: Saint Gobain C1100F is discontinued effective 12/31/10.</li> <li>• Thermal performance data are provided for reference only. Actual performance may vary by application.</li> <li>• ATS reserves the right to update or change its products without notice to improve the design or performance.</li> <li>• ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant.</li> <li>• Optional <b>maxiGRIP™</b> Installation/Removal Tool Set P/N: <b>MGT190</b></li> <li>• Contact ATS to learn about custom options available.</li> </ul>						

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), [sales@qats.com](mailto:sales@qats.com) or [www.qats.com](http://www.qats.com).

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